

IN THE CLAIMS

Please cancel claims 29-30, 38-39 and 47-48 without prejudice or disclaimer of their underlying subject matter.

Please amend the claims as follows.

22. (currently amended, claim 30 placed into independent form) A thin film semiconductor device comprising:

a product substrate and a thin film device,
wherein a manufacturing substrate is of an inorganic material,
wherein said product substrate is one of an organic material and
a metal,
wherein said product substrate has a first side and a second side
opposed to said first side,
wherein said manufacturing substrate is adjacent said first side,
said manufacturing substrate being closer to said first side
than to said second side,
wherein said thin film device is adjacent said second side, said
thin film device being closer to said second side than to
said first side,
wherein said product substrate is between said thin film device
and said manufacturing substrate,
wherein said manufacturing substrate is removed to expose said
first side, thereby leaving said product substrate and said
thin film device,

wherein an adhesive layer is formed between said first surface
and said manufacturing substrate,
wherein said adhesive layer is dissolved to remove said
manufacturing substrate.

23. (previously presented) A thin film semiconductor device as claimed in claim 22, wherein said manufacturing substrate is a glass substrate.

24. (previously presented) A thin film semiconductor device as claimed in claim 22, wherein said thin film device is a thin film transistor.

25. (previously presented) A thin film semiconductor device as claimed in claim 22, wherein said metal is aluminum.

26. (previously presented) A thin film semiconductor device as claimed in claim 22, wherein said organic material is a plastic.

27. (previously presented) A thin film semiconductor device as claimed in claim 26, wherein a moisture-proof buffer film is formed between said second surface and said thin film device.

28. (previously presented) A thin film semiconductor device as claimed in claim 26, wherein said plastic is from the group comprising polyether sulfone resin, polyethylene terephthalate resin and ARTON resin.

29-30. (canceled)

31. (currently amended) A thin film semiconductor device as claimed in claim ~~29~~22, wherein said adhesive layer is from the group comprising a polyimide, Teflon resin, silicon, germanium and metal.

32. (currently amended, claim 39 placed into independent form) A liquid crystal display device comprising:

a product substrate and a pixel array,
wherein a manufacturing substrate is of an inorganic material,
wherein said product substrate is one of an organic material and
a metal,
wherein said product substrate has a first side and a second side
opposed to said first side,
wherein said manufacturing substrate is adjacent said first side,
said manufacturing substrate being closer to said first side
than to said second side,
wherein said pixel array is adjacent said second side, said pixel
array being closer to said second side than to said first
side,

wherein said product substrate is between said pixel array and
said manufacturing substrate,

wherein said manufacturing substrate is removed to expose said
first side, thereby leaving said product substrate and said
pixel array,

wherein an adhesive layer is formed between said first surface
and said manufacturing substrate,

wherein said adhesive layer is dissolved to remove said
manufacturing substrate.

33. (previously presented) A liquid crystal display device
as claimed in claim 32, wherein said manufacturing substrate is a
glass substrate.

34. (previously presented) A liquid crystal display device
as claimed in claim 32, wherein said metal is aluminum.

35. (previously presented) A liquid crystal display device
as claimed in claim 32, wherein said organic material is a
plastic.

36. (previously presented) A liquid crystal display device
as claimed in claim 35, wherein a moisture-proof buffer film is
formed between said second surface and said pixel array.

37. (previously presented) A liquid crystal display device as claimed in claim 35, wherein said plastic is from the group comprising polyether sulfone resin, polyethylene terephthalate resin and ARTON resin.

38-39. (canceled)

40. (currently amended) A liquid crystal display device as claimed in claim ~~38~~32, wherein said adhesive layer is from the group comprising a polyimide, Teflon resin, silicon, germanium and metal.

41. (currently amended, claim 48 placed into independent form) A electroluminescence display device comprising:

a product substrate and an electroluminescence device ,
wherein a manufacturing substrate is of an inorganic material,
wherein said product substrate is one of an organic material and
a metal,
wherein said product substrate has a first side and a second side
opposed to said first side,
wherein said manufacturing substrate is adjacent said first side,
said manufacturing substrate being closer to said first side
than to said second side,
wherein said electroluminescence device is adjacent said second
side, said electroluminescence device being closer to said
second side than to said first side,

wherein said product substrate is between said
electroluminescence device and said manufacturing substrate,
wherein said manufacturing substrate is removed to expose said
first side, thereby leaving said product substrate and said
electroluminescence device,
wherein an adhesive layer is formed between said first surface
and said manufacturing substrate,
wherein said adhesive layer is dissolved to remove said
manufacturing substrate.

42. (previously presented) A electroluminescence display
device as claimed in claim 41, wherein said manufacturing
substrate is a glass substrate.

43. (previously presented) A electroluminescence display
device as claimed in claim 41, wherein said metal is aluminum.

44. (previously presented) A electroluminescence display
device as claimed in claim 41, wherein said organic material is a
plastic.

45. (previously presented) A electroluminescence display
device as claimed in claim 44, wherein a moisture-proof buffer
film is formed between said second surface and said
electroluminescence device.

46. (previously presented) A electroluminescence display device as claimed in claim 44, wherein said plastic is from the group comprising polyether sulfone resin, polyethylene terephthalate resin and ARTON resin.

47-48. (canceled)

49. (currently amended) A electroluminescence display device as claimed in claim ~~47~~41, wherein said adhesive layer is from the group comprising a polyimide, Teflon resin, silicon, germanium and metal.